

*Information Society Technologies
in the 6th Framework Programme*

IST Work Programme 2005-2006

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Embedded Systems*



European Commission



Information Society



SIXTH FRAMEWORK
PROGRAMME

Outline of presentation



- IST in FP6
 - objectives and vision
- Results of IST Calls in 2003-04
 - projects and participation
- IST Work Programme 2005-2006
 - technology trends
 - embedded systems SO
 - budget



IST in FP6 - objectives & strategy

- Main objectives

- Establishing Europe's leadership in the technologies at the heart of the knowledge economy and society
- Strengthening Europe's competitiveness
- Building the information and knowledge society for ALL

- Strategy

- Concentration and focus, building critical mass
- Visionary, forward looking (longer term / high risk)
- Scope of activities: Core technologies & “pull-through” applications



The IST vision

- Moving to an era where “our surrounding is the interface” to IST applications & services
 - Bringing people to the foreground
 - Building trustful technologies for the background
- ICT will:
 - be embedded everywhere, in everyday objects (furniture, clothes, vehicles, buildings,...)
 - adapt to people and business needs
 - enable multi-sensorial interfaces (beyond PCs, screens & keyboards)
 - Allow seamless access to information and services



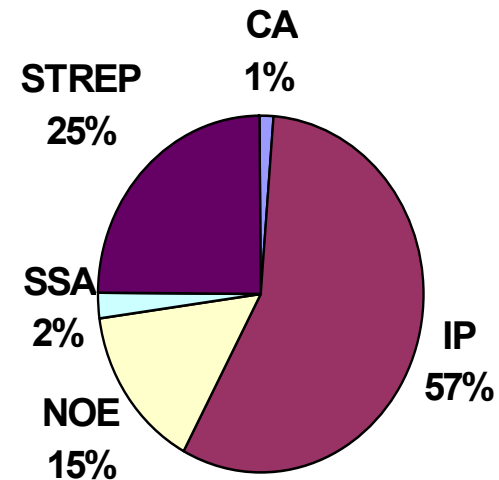
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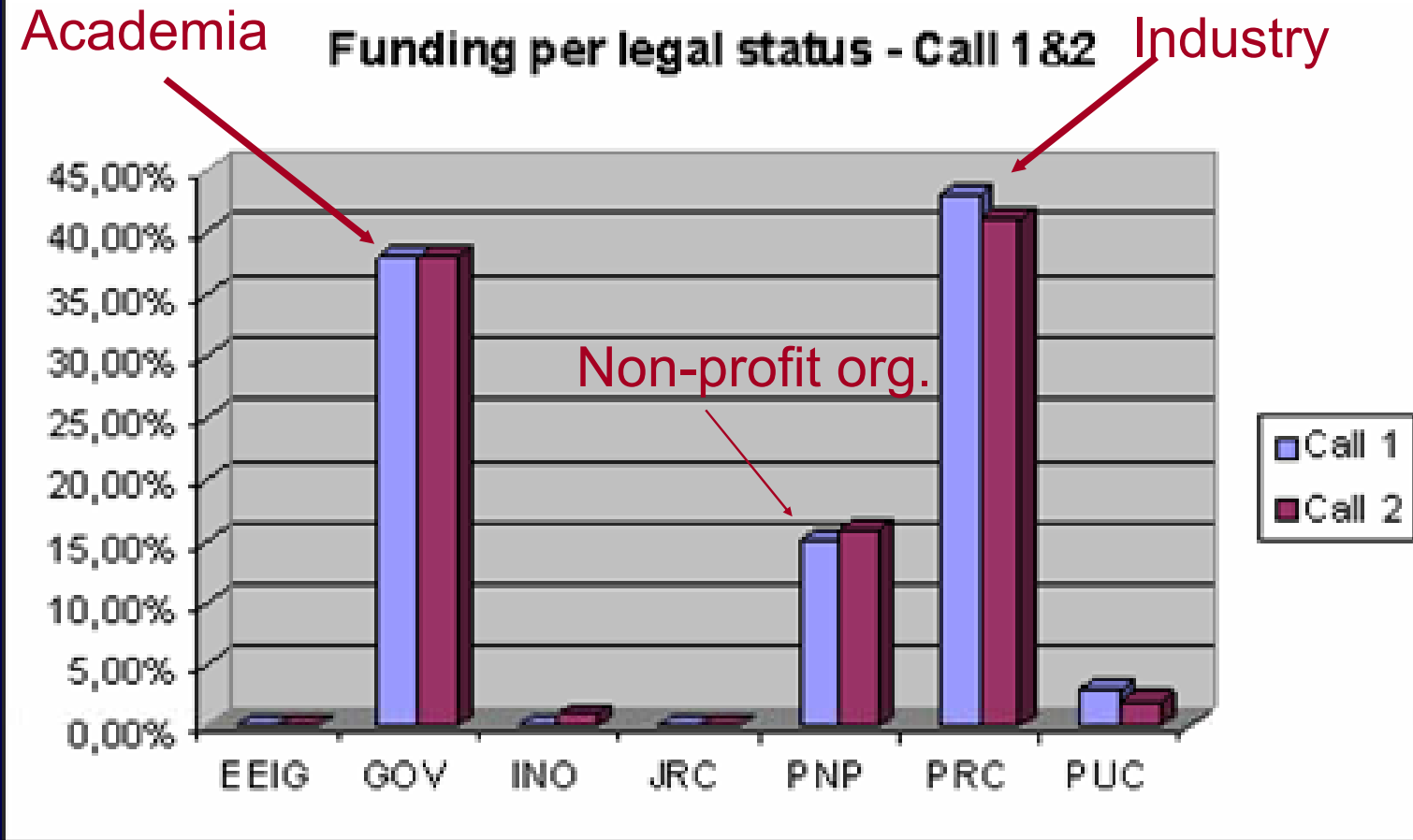
IST Calls 2003-04 : Implementation

- 1,9 out of 3,8 Billion € spent in calls in 2003-04
- More than 400 projects supported
 - Out of 2500 proposals received
- More than 6500 participations
- ☹ Oversubscription



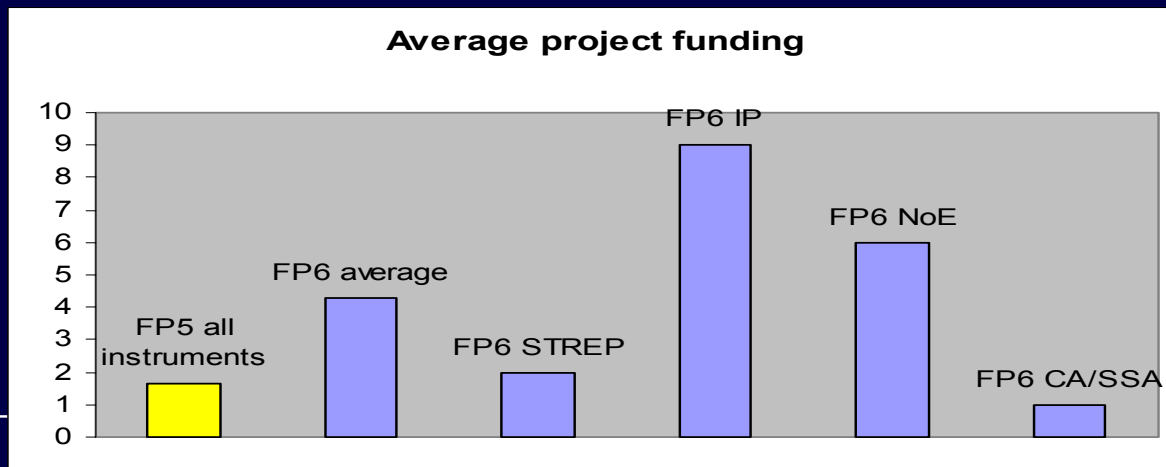
Funding per Instrument
IST Calls 1 & 2

IST Calls 2003-04 : Participation



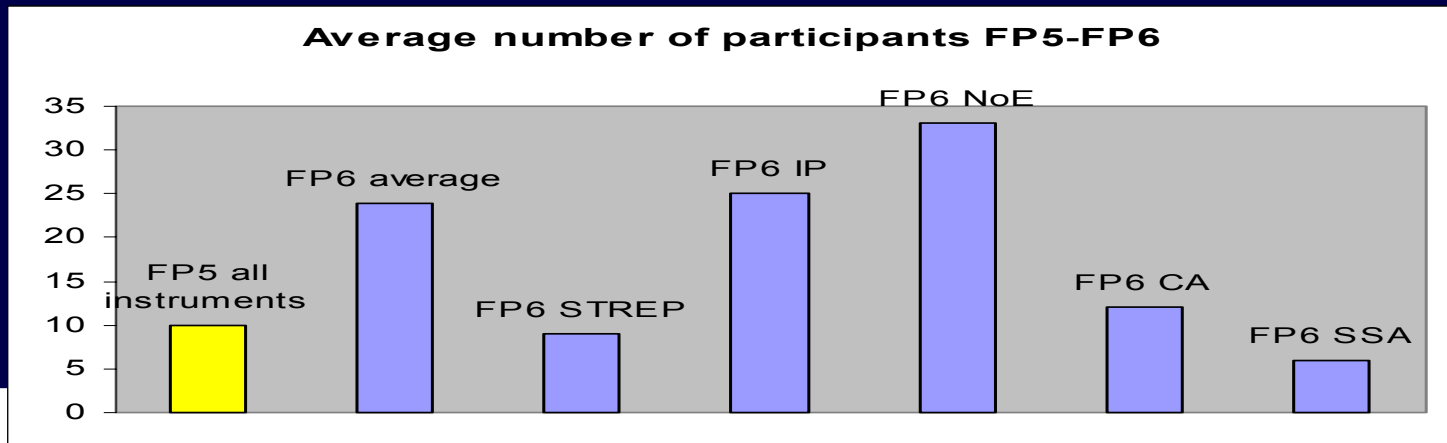
IST Calls 2003-04 : Concentration

- Concentration of effort and building critical mass
 - Total number of projects selected :
3 times less than FP5 for an equivalent budget
 - Average budget of Integrated Projects :
5 times larger than FP5 projects
- ☺ Setting up & managing larger projects : a challenge



IST Calls 2003-04 : Integration

- More intensive collaboration between various actors
 - Integrated Projects: 2-3 times as many partners per project
 - From industry, academia and public research labs
- ☹ Concern over SME participation
- ☹ Integration of effort in an enlarged Europe important
- ☹ International co-operation



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 - structure and budget
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Technology trends

- Increasing pervasiveness of ICT
 - Innovation from ICT use in different fields
- Increasing convergence
 - Within ICT
 - Communications/computing/control/media, fixed/wireless, etc.
 - Between ICT and other fields
 - Info-bio-cogno-nano
- Higher levels of complexity
 - Combination of skills and know how
 - Building increasingly complex systems – that are simple for the user!



Lessons learnt from previous calls

- **Oversubscription**
 - **Need for more focus and precision**
 - Action: no specific topic on control in Embedded Systems SO, 2005-06
- **SME participation**
 - **Call1: 16%; Call2: 17%; NoEs: 7%; IPs: 15%; STREPs: 24%**
 - Action: more budget allocated to STREPs and specific action on SMEs
- **Participation of new Member States and Associated Candidate Countries**
 - **Calls 1 and 2: 3 and 4 %**
 - Action: A dedicated Strategic Objective: “Strengthening the integration of the ICT research effort in an enlarged Europe” (63 MEuro) -Calls for STREPs in eGov, eBus, eLearning and eHealth
- **International co-operation**
 - **Domain-specific approaches are needed**
 - Action: call 3 was used to set-up specific actions on this. International co-operation is also possible in Call 4+5



Embedding intelligence everywhere

- **Embedded Systems (= electronics + software) underpin Europe's industrial strongholds**
 - Automotive, avionics, consumer electronics, telecommunications, plant automation, medical,...
- **Enormous potential for the future**
 - Key enabler for competitiveness and innovation
 - Creation of new markets and societal-scale applications
- **Major challenges**
 - In science, technology, education, infrastructures

Embedded systems provide the added value of European products

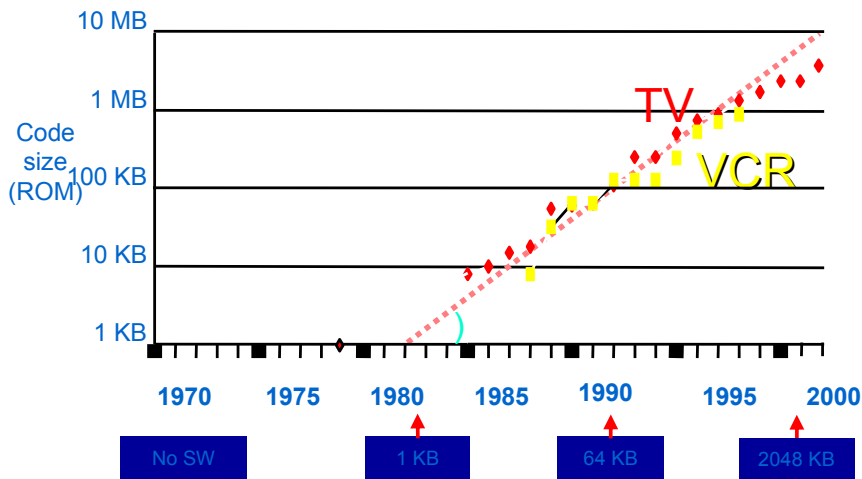


Embedded systems facts and figures

- 18 of top 25 EU companies rely on embedded systems
 - Overall R&D spending: 50 billion annually
- Embedded Systems feature strong growth
 - Number of embedded components expected to grow to 16 billion worldwide by 2010
 - Electronics will account for up to 40% of a vehicle's value by 2010
 - A smart phone contains millions of lines of code
 - Annual growth rate 10.3%
- Embedded systems – a European strength

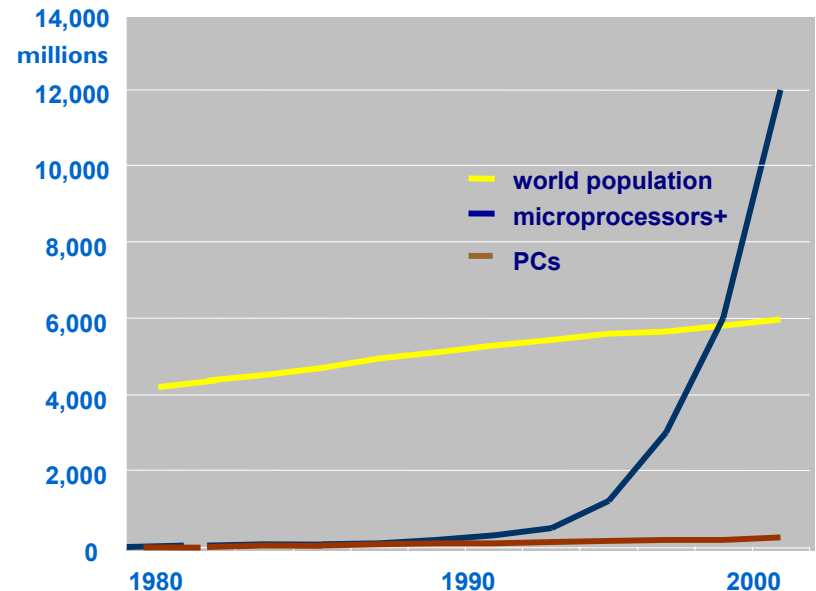
Exponential growth of embedded systems

embedded software

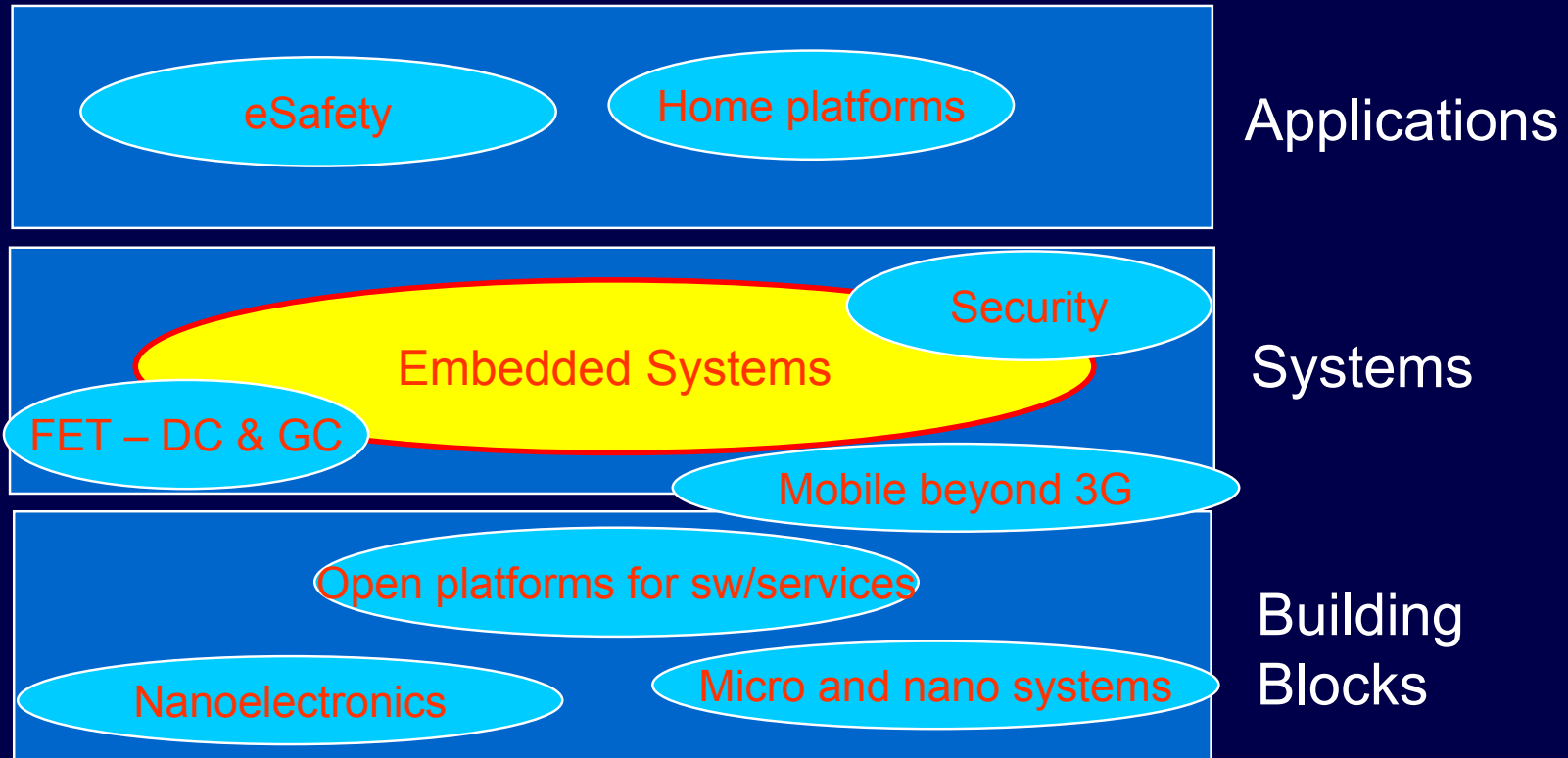


Source: Philips Research

embedded electronics



Embedded Systems - relation to other areas



+ ITEA, MEDEA, DG RTD,...

Project inventory

System Design

- **12 projects; 5 from 2nd call; 4 new instruments**
 - ARTIST2 (NoE): virtual centre of excellence in Embedded System Design
 - HiPEAC (NoE): design and implementation of high performance embedded computing
 - DECOS (IP): generic composable hardware and software components for TTA
 - ASSERT (IP): new system and software development approach based on proof obligations at each step
 - ICODES (STREP): design technology for embedded systems containing many heterogeneous communicating components in hardware and software

Networked Embedded System

- **10 projects; 8 from 2nd call; 1 new instrument**
 - RUNES (IP): adaptable networked embedded systems everywhere by adaptive, self-configurable middleware layer
 - 7 STREPs from call 2

Advanced Control

- **12 projects; 3 from 2nd call; 1 new instrument**
 - HYCON (NoE): virtual institute in the area of Hybrid Control integrating tools and centres of excellence
 - 2 STREPs from call 2
 - Joint call 3: 1 integrated project

Embedded systems

68 MEuro



- Key Objectives

- Hardware/software systems embedded in intelligent devices
- Cost-efficient ambient intelligence systems with optimal performance, high confidence, reduced time to market and faster deployment

- Focus

- System Design (IPs, STREPs, SSAs, CAs)
 - Model-based system design, validation and testing.
 - Design methods, programming models and compilation tools for reconfigurable architectures
- Networked Embedded Systems (all instruments)
 - Middleware for wireless objects
 - Scalable and self-organising platforms
- SME embedded tool developers and vendors

Embedded Systems in WP 2005–2006

Other issues:

- ***SME's***
 - Interoperability and complementary of design and software tools to increase integration of the tool chain
- ***International co-operation***
 - United States, Korea, Japan or other countries
- ***Cooperation with EUREKA***
 - Mainly ITEA and MEDEA+

Embedded Systems Information day – 16 March 2005



International cooperation

- Participation from third countries is possible
- Funding is available for developing countries, Mediterranean, Western Balkan, Russia and NISs
- Normally no funding for developed third countries
- 2 possibilities for embedded systems exists:
 - a) to join European research project
 - b) preparatory action for international cooperation
 - SSA or CA
 - preparation of joint research agenda on topics that would require joint effort



Budget Distribution

- Total budget for WP2005-06: 1,8 B€
- Pre-allocation of 90% of budget
- Embedded Systems: 68M €
- Instruments IP and NoE: 60% of budget
- Instruments STREP/CA/SSA: 40% of budget
- Call is expected to open on: 17 May 2005
- Call is expected to close on: 21 September 2005



For Further Information

General FP6:

<http://europa.eu.int/comm/research/fp6/>

<http://www.cordis.lu/>

IST:

<http://www.cordis.lu/ist>

Embedded Systems:

http://www.cordis.lu/ist/directorate_c/ems

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